

Rosemont, IL, USA - March 2018

Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Credit
Abbott, John	Corning Incorporated	Corning Incorporated	1	1	1	1	4
Abbott, Justin	Lumentum	Lumentum		1	1	1	3
Abramson, David	Texas Instruments Incorporated	Texas Instruments Incorporated		1		1	2
Aekins, Rob	Legrand	Legrand		1	1		2
Agnes, Andrea	STMicroelectronics	STMicroelectronics		1	1	1	3
Ahmad, Bilal	Huawei Canada Research Centre	Huawei Canada Research Centre			1		1
An, Hongming	Microchip Technology, Inc.	Microchip Technology, Inc.	1				1
Anslow, Peter	Ciena Corporation	Ciena Corporation	1	1	1	1	4
Babenko, Oleksandr	Molex Incorporated	Molex Incorporated	1	1	1	1	4
BACA, RICHARD	Microsoft Corporation	Microsoft Corporation		1	1	1	3
Balasubramonian, Venugopal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.			1	1	2
Baldwin, Thananya	Keysight Technologies	Keysight Technologies	1	1	1	1	4
Baran, David	ARRIS Group	ARRIS Group		1			1
Beauregard, Francois	Belden	Belden	1	1	1	1	4
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	4
Bernstein, Gary	Leviton Manufacturing Co.	Leviton Manufacturing Co.		1	1		2
Beruto, Piergiorgio	Canovatech S.r.l.	Canova Tech Srl	1	1		1	3
bo, gao	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd	1	1	1	1	4
Booth, Brad	Microsoft Corporation	Microsoft Corporation	1	1	1	1	4
Brandt, David	Rockwell Automation	Rockwell Automation	1	1		1	3
Braun, Ralf-Peter	Deutsche Telekom AG	Deutsche Telekom AG	1	1	1	1	4
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions	1	1	1	1	4
Brown, Alan M	ADTRAN Inc.	ADTRAN Inc.	1	1	1		3
Brown, Matthew	MACOM	MACOM	1	1	1	1	4
Brownlee, Phillip	TDK Corporation	TDK Corporation	1	1	1	1	4
Brychta, Michal	Analog Devices Inc.	Analog Devices Inc.	1	1		1	3
Bullock, Chris	Cisco Systems, Inc.	Cisco Systems, Inc.			1	1	2
Burrell, Gary	Elenion Technologies	Elenion Technologies	1	1	1	1	4
Butter, Adrian	GLOBALFOUNDRIES	GLOBALFOUNDRIES	1	1	1	1	4
Calvin, John	Vital Technical Marketing, Wilder Techno	VTM, V-Prime, Wilder Technologies	1	1	1	1	4
Carlson, Craig	Cavium	Cavium		1	1	1	3
Carlson, Steven	High-Speed Design Inc.	Robert Bosch GmbH	1	1	1	1	4

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Carty, Clark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Castro, Jose		Panduit Corp.	1	1	1		3
Chabot, Craig	University of New Hampshire InterOpera	University of New Hampshire InterOpera	1	1	1	1	4
Chalupsky, David	Intel Corporation	Intel Corporation	1	1	1	1	4
Chang, Yongmao	Inphi Corporation	Inphi Corporation	1	1	1	1	4
Chen, Chan	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc.	1	1	1		3
Cheng, Weiyang	Coriant	Coriant	1	1		1	3
Choudhury, Golam	OFS	OFS	1	1	1	1	4
Colella, Barry	Source Photonics	Source Photonics		1			1
Dai, Eugene	Cox Communications Inc.	Cox Communications Inc.		1	1		2
D'Ambrosia, John	Futurewei Technologies	Futurewei (Subsidiary of Huawei)	1	1	1	1	4
Darshan, Yair	Microsemi Corporation	Microsemi Corporation			1	1	2
Dawe, Piers J G	Mellanox Technologies	Mellanox Technologies	1	1	1	1	4
Dawson, Fred	Chemours Canada Company	Chemours Canada Company			1	1	2
DeSanti, Claudio	Google	Google	1	1	1	1	4
DiBiaso, Eric	TE Connectivity	TE Connectivity	1	1	1	1	4
Diminico, Christopher	M C Communications, LLC	Panduit Corp.	1	1	1	1	4
Djahanshahi, Hormoz	Microsemi Corporation	Microsemi Corporation		1	1	1	3
Donahue, Curtis	University of New Hampshire InterOpera	UNH-IOL		1	1	1	3
Du, Liang	Google	Google	1	1	1	1	4
Dudek, Michael	Cavium	Cavium	1	1	1	1	4
Effenberger, Frank	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Ewen, John	GLOBALFOUNDRIES	GLOBALFOUNDRIES	1	1	1	1	4
Eyal, Massad	Valens Semiconductor	Valens Semiconductor			1		1
farjad, ramin	Aquantia	Aquantia			1	1	2
Fathi Moghadam, Borhan	NVIDIA Corporation	NVIDIA Corporation	1	1	1	1	4
Ferretti, Vincent	Corning Incorporated	Corning Incorporated	1	1	1	1	4
Franchuk, Brian	Emerson Automation Solutions	Emerson Automation Solutions	1	1	1	1	4
Fritsche, Matthias	HARTING Technologie Gruppe	HARTING Electronics GmbH	1	1	1	1	4
Frosch, Richard	Phihong USA Inc,	Phihong USA Inc,			1	1	2
fu, shiyong	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Fukutoku, Mitsunori	Nippon Telegraph and Telephone Corpor	Nippon Telegraph and Telephone Corpor	1	1	1	1	4

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Gardner, Mike	Molex Incorporated	Molex Incorporated	1	1	1	1	4
Gauthier, Claude	OmniPhy	OmniPhy	1	1	1		3
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC, Huawei LTD	1	1	1	1	4
Goergen, Joel	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Gong, Zhigang	O-Net Communications Ltd.	O-Net Communications Ltd.	1		1	1	3
Gorshe, Steven Scott	Microsemi Corporation	Microsemi Corporation			1	1	2
Graber, Steffen	Pepperl+Fuchs GmbH	Pepperl+Fuchs GmbH	1	1		1	3
Grau, Olaf	Robert Bosch GmbH	Robert Bosch GmbH	1	1	1	1	4
Grow, Robert	RMG Consulting	RMG Consulting		1	1	1	3
Gustlin, Mark	Xilinx Inc	Xilinx		1	1	1	3
Hajduczenia, Marek	Charter Communications	Charter Communications	1	1	1	1	4
Harstead, Ed	Nokia	Nokia		1			1
Hayakawa, Akinori	FUJITSU LABORATORIES LIMITED	FUJITSU LABORATORIES LIMITED	1	1	1	1	4
Haynes, Hayden	University of New Hampshire InterOper	University of New Hampshire InterOpera	1	1	1	1	4
Healey, Adam	Broadcom Ltd.	Broadcom Ltd.	1	1	1	1	4
Heck, Howard	Intel Corporation	Intel Corporation	1	1	1	1	4
Hegde, Rajmohan	Broadcom Corporation	Broadcom Ltd.	1	1	1	1	4
Hess, David	CORD DATA	CORD DATA		1	1	1	3
Holden, Brian	Kandou Bus	Kandou Bus	1	1	1		3
Horner, Rita	Synopsys, Inc.	Synopsys, Inc.	1	1	1		3
Huang, PAUL	Panduit Corp.	Panduit Corp.		1	1		2
Huszak, Gergely	Self	Kone	1	1	1	1	4
Ingham, Jonathan	Foxconn Interconnect Technology	Foxconn Interconnect Technology		1	1	1	3
ingrassia, alessandro	canova tech	canova tech		1		1	2
Isono, Hideki	FUJITSU	Fujitsu Optical Components Limited	1	1	1	1	4
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co. Ltd	1	1	1	1	4
Jackson, Kenneth	Sumitomo Electric Device Innovations, U	Sumitomo Electric Industries, LTD	1	1	1	1	4
Jansen, Mark	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD			1		1
Jimenez, Andrew	Anixter Inc.	Anixter Inc.	1	1	1	1	4
Johnson, John	Broadcom Limited	Broadcom Limited	1	1	1	1	4
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Kabra, Lokesh	Synopsys, Inc.	Synopsys, Inc.	1	1		1	3

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Kao, Chienping	Intel Corporation	Intel	1	1	1	1	4
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Katz, David	Phoenix Contact	Phoenix Contact	1	1	1	1	4
Kawatsu, Yasuaki	APRESIA Systems	Hitachi Metals, Ltd.	1	1	1	1	4
Kim, Andrew	Spectra7 Microsystems	Spectra7 Microsystems	1	1	1	1	4
Kimber, Eric	Semtech Ltd	Semtech Ltd	1	1	1		3
King, Jonathan	Finisar Corporation	Finisar Corporation		1	1		2
Kiuchi, Hideki	Japan Aviation Electronics Ind., LTD. (JAE)	Japan Aviation Electronics Ind., LTD. (JAE)	1				1
Knittle, Curtis	Cable Television Laboratories Inc. (Cable)	Cable Television Laboratories Inc. (Cable)	1	1	1		3
Kochuparambil, Elizabeth	Cisco Systems, Inc.	Cisco Systems, Inc.	1		1	1	3
Kolesar, Paul	CommScope	CommScope, Inc.		1	1	1	3
Kondo, Taiji	MegaChips Corporation	MegaChips Corporation	1	1	1	1	4
Kramer, Glen	Broadcom Corporation	Broadcom Corporation		1	1	1	3
Krieger, Olaf	Volkswagen AG	Volkswagen AG	1	1	1	1	4
Lackner, Hans	QoSCom GmbH	QoSCom - Quality in Communications - G	1	1	1	1	4
Lapak, Jeffrey	University of New Hampshire InterOpera	University of New Hampshire InterOpera	1	1	1	1	4
Laubach, Mark	Broadcom Limited	Broadcom Corporation	1	1	1	1	4
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1	4
Lawlis, James	Ford Motor Company	Ford Motor Company	1				1
Le Cheminant, Greg	Keysight Technologies	Keysight Technologies		1	1	1	3
Lee, June Hee	SAMSUNG ELECTRONICS	SAMSUNG ELECTRONICS	1	1	1	1	4
Lenz, Sean	Panduit Corp.	Panduit Corp.	1				1
Lewis, David	Lumentum Inc.	Lumentum Inc.	1	1	1	1	4
Lewis, Jon	Dell EMC	Dell	1	1	1	1	4
Li, David	Ligent Photonics, Inc.	Hisense-Ligent		1	1	1	3
Li, Mike-Peng	Intel Corporation	Intel Corporation		1	1	1	3
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Lin, Alex	MediaTek	MediaTek Inc.	1	1	1	1	4
Lingle, Robert	OFS	OFS	1	1		1	3
liu, dekun	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	1	1		3
Liu, Karen	Kaiam Corp	Kaiam Corporation	1	1	1	1	4
Liu, Zhenyu	Credo Semiconductor	Credo Semiconductor	1	1	1	1	4

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Lukacs, Miklos	Silicon Laboratories	Silicon Laboratories		1	1	1	3
Lusted, Kent	Intel Corporation	Intel Corporation	1	1	1	1	4
Madgar, Zahy	Valens Semiconductor	Valens Semiconductor			1	1	2
Maguire, Valerie	The Siemon Company	The Siemon Company	1	1	1	1	4
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	4
Malicoat, David	Malicoat Networking Solutions	Aquantia; SENKO Advanced Components	1	1	1	1	4
Marques, Flavio		FURUKAWA ELECTRIC	1	1	1	1	4
Matheus, Kirsten	BMW Group	BMW Group	1	1	1	1	4
Matoglu, Erdem	Amphenol Corporation	Amphenol Corporation	1	1	1	1	4
Matola, Laurence	Delphi Corporation	Aptiv LLP	1	1	1	1	4
Mazzini, Marco	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
McCarthy, Mick	Analog Devices Inc.	Analog Devices Inc.	1	1		1	3
Mcclellan, Brett	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1		3
McMillan, Larry	Western Digital Corporation	Western Digital Corporation	1		1	1	3
McSorley, Gregory	Amphenol Corporation	Amphenol Corporation		1	1	1	3
Mei, Richard	INDEPENDENT	CommScope, Inc.		1	1	1	3
Mein, John	DustPhotonics, INC.	DustPhotonics, LTD	1	1	1	1	4
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.	1	1	1	1	4
Miao, Guangjun		MediaTek Inc.	1	1	1	1	4
Migulez, Phil	Comcast	Comcast	1	1	1		3
Miller, Martin	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1		3
Moritake, Toshiyuki	Japan Aviation Electronics Ind., LTD. (JAE)	Japan Aviation Electronics Ind., LTD. (JAE)	1	1	1		3
Mueller, Thomas	Rosenberger	Rosenberger	1	1	1	1	4
Nakamoto, Edward	Spirent Communications	Spirent Communications	1	1	1	1	4
Neveux, Paul	Superior Essex	Superior Essex	1	1	1	1	4
Nolan, John	QLogic Corporation	QLogic Corporation	1	1	1	1	4
Noll, Kevin	TiBIT Communications	Tibit Communications	1	1	1		3
Nordin, Ronald	Panduit Corp.	Panduit Corp.	1		1		2
Novick, Asher	Panduit Corp.	Panduit Corp.		1	1		2
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	4
Ohni, Josef	MD Elektronik GmbH	MD Elektronik	1		1	1	3

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Oliver, Douglas	Ford Motor Company	Ford Motor Company	1	1	1	1	4
Pachon, Arturo	TE Connectivity	TE Connectivity	1	1	1	1	4
Palkert, Thomas	EIC	Molex-Macom	1	1	1	1	4
Pandey, Sujan	NXP Semiconductors	NXP Semiconductors	1	1	1	1	4
Pardo, Carlos	Knowledge Development for POF SL	KDPOF		1	1	1	3
Parsons, Earl	CommScope, Inc.	CommScope, Inc.	1	1	1	1	4
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation			1		1
Patel, Harsh	Molex LLC	Molex LLC			1	1	2
Pepper, Gerald	Keysight Technologies	Keysight Technologies	1	1	1	1	4
Pham, Phong	US Conec, Ltd.	US Conec, Ltd.	1	1	1	1	4
Piehler, David	Dell	Dell	1	1	1	1	4
Pimpinella, Rick	Panduit Corp.	Panduit Corp.	1	1	1	1	4
Pondillo, Peter	Corning Incorporated	Corning Incorporated	1	1	1		3
Posthuma, Carl	Nokia	Nokia	1		1	1	3
Powell, William	Nokia	Nokia	1	1	1	1	4
Pozzebon, Dino	Microsemi Corporation	Microsemi Corporation	1	1	1	1	4
Rabinovich, Rick	Keysight Technologies	Keysight Technologies	1	1	1	1	4
Rechtman, Zvi	Mellanox Technologies	Mellanox Technologies	1	1	1	1	4
Remein, Duane	Futurewei Technologies	Huawei Technologies Co. Ltd	1	1	1	1	4
Renteria, Victor	Bel Fuse	Bel Fuse	1	1	1	1	4
Ressler, Michael	Hitachi Cable America Inc.	Hitachi Cable America Inc.	1	1	1	1	4
Rotolo, Salvatore	STMicroelectronics	STMicroelectronics	1	1	1	1	4
Rubino, Litsa	Delphi Corporation	Delphi Corporation	1	1	1	1	4
Rysin, Alexander	Mellanox Technologies	Mellanox Technologies	1	1	1	1	4
Sakai, Toshiaki	Socionext	socionext	1	1	1	1	4
Samamra, Raed		Prysmian Cables & Systems		1	1		2
Sambasivan, Sam	AT&T	AT&T	1	1	1	1	4
Sayre, Edward	Samtec, Inc.	Teraspeed, a division of Samtec	1	1	1	1	4
Scantamburlo, Nicola	Canova Tech	Canova Tech	1	1		1	3
Schmitt, Matthew	Cable Television Laboratories Inc. (Cable	Cable Television Laboratories Inc. (Cable			1	1	2
Schuessler, James	SAMSUNG ELECTRONICS	SAMSUNG ELECTRONICS		1	1	1	3
Sekel, Steve	Keysight Technologies	Keysight Technologies	1	1	1	1	4

IEEE 802.3 - Attendance and Affiliation Sheet

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Credit
Shariff, Masood	CommScope, Inc.	CommScope, Inc.	1	1	1	1	4
Shen, Zuowei	Google	Google				1	1
Shigematsu, Masayuki	Innovation Core SEI	Innovation Core SEI			1		1
Shirao, Mizuki	Mitsubishi Electric Corporation	Mitsubishi Electric Corporation		1	1	1	3
Skiest, Stephen	Panduit	Panduit Corp.	1	1	1	1	4
Slavick, Jeff	Broadcom Limited	Broadcom Limited	1	1	1	1	4
Smith, Daniel	Seagate Technology LLC	Seagate Technology LLC	1	1	1	1	4
Sommers, Scott	Molex Incorporated	Molex Incorporated	1	1	1	1	4
Souvignier, Tom	Broadcom Corporation	Broadcom Corporation			1		1
Sparrowhawk, Bryan	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1	1	1	4
Specht, Johannes	University of Duisburg-Essen	University of Duisburg-Essen		1			1
Sprague, Edward	Infinera Corporation	Infinera Corporation	1	1	1	1	4
Srivastava, Atul	NEL-America	NTT Electronics			1		1
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Stewart, Heath	Analog Devices Inc.	Analog Devices Inc.	1	1	1		3
Stone, Robert	Broadcom Corporation	Broadcom Corporation			1		1
Stover, David	Analog Devices Inc.	Analog Devices Inc.	1	1	1	1	4
Tai, Bright	TAICS	TAICS	1		1	1	3
Tailor, Bharat	Semtech Canada Corporation	Semtech Canada Corporation	1	1	1	1	4
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	FUJITSU LABORATORIES LIMITED	1	1	1		3
TAZEBAY, MEHMET	Broadcom Corporation	Broadcom Corporation	1	1	1	1	4
Tellas, Ronald	Belden	Belden	1	1	1		3
Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT	1	1		1	3
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Tracy, Nathan	TE Connectivity	TE Connectivity	1	1	1	1	4
Tremblay, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise		1	1	1	3
Trowbridge, Stephen	Nokia	Nokia	1	1	1	1	4
TSENG, TA CHIN	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.	1	1	1	1	4
Twombly, Jeff	Credo Semiconductor	Credo Semiconductor			1	1	2
Ulrichs, Ed	Source Photonics	Source Photonics	1	1	1	1	4
Umeda, Daisuke	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD	1	1	1	1	4
Vaden, Sterling	Vaden Enterprises	Vaden Enterprises		1	1	1	3

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Vanderlaan, Paul	Berk-Tek LLC	Berk-Tek LLC	1	1	1	1	4
Vernickel, Ricky	LEONI	LEONI	1		1	1	3
Vitali, Marco	Sicoya	Sicoya	1	1	1		3
Voss, Robert	Panduit Corp.	Panduit Corp.		1	1		2
Walker, Clinton	Intel Corporation	Intel Corporation		1	1		2
Walker, Dylan	Cisco Systems, Inc.	Cisco Systems, Inc.		1	1	1	3
Walter, Edward	AT&T	AT&T		1	1		2
wang, haifei	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd	1	1	1	1	4
Wang, Hui	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.			1	1	2
Wang, Roy	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1	4
Wang, Tongtong	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Wen, Yida	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1		1	1	3
Wey, Jun Shan	ZTE Corporation	ZTE Corporation	1	1	1		3
white, martin	Cavium	Cavium		1	1	1	3
Wienckowski, Natalie	General Motors Company	General Motors Company	1	1	1	1	4
Williams, Tom	Acacia Communications	Acacia Communications			1		1
Withey, James	Fluke Corporation	Fluke Corporation	1	1	1	1	4
Woodman, Bradley	Molex Incorporated	Molex Incorporated	1	1			2
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1		3
Wucher, Markus	Endress + Hauser Flowtec AG	Endress + Hauser	1	1		1	3
XU, LI	Huawei Technologies Co. Ltd	HUAWEI	1	1	1	1	4
Xu, Yu	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1		3
Yamamoto, Shuto	Nippon Telegraph and Telephone Corpor	Nippon Telegraph and Telephone Corpor	1	1	1	1	4
Yasueda, Jim	Teledyne Lecroy	Teledyne Lecroy			1		1
Young, Adrian	Leviton Manufacturing Co.	Leviton Manufacturing Co.		1	1	1	3
Young, James	CommScope, Inc.	CommScope	1	1	1	1	4
Yseboodt, Lennart	Philips Lighting	Philips Electronics	1	1	1	1	4
Zambell, Andrew	Amphenol Corporation	Amphenol-FCI	1	1	1	1	4
Zerna, Conrad	Fraunhofer IIS	Fraunhofer IIS	1	1	1	1	4
Zhang, Junwen	ZTE TX Inc	ZTE TX Inc	1	1	1		3
ZHANG, YUN	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd	1	1	1	1	4
Zhong, Qiwen	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1				1

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Zhou, Richard (Yujia)	Charter Communications	Charter Communications		1	1	1	3
Zhuang, Yan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Zielinski, Martin	Emerson Electric Co.	Emerson Process Management	1	1	1	1	4
Zimmerman, George	CME Consulting	ADI, APL Group, Aquantia, BMW, Comms	1	1	1	1	4
Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.		1	1	1	3
Zweck, Harald	Infineon Technologies AG	Infineon Technologies AG	1	1			2